

SANYO Semiconductors DATA SHEET

2SC6071 — NPN Epitaxial Planar Silicon Transistor

High-Current Switching Applications

Applications

· Relay drivers, lamp drivers, motor drivers.

Features

- · Adoption of MBIT process.
- · Large current capacitance.
- · Low collector-to-emitter saturation voltage.
- · High-speed switching.

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		120	V
Collector-to-Emitter Voltage	VCES		120	V
Collector-to-Emitter Voltage	VCEO		50	V
Emitter-to-Base Voltage	VEBO		8	V
Collector Current	IC		10	Α
Collector Current (Pulse)	ICP	PW≤100μs	13	Α
Base Current	ΙB		2	Α
Collector Dissipation	Do.		0.95	W
	PC	Tc=25°C	20	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Oill
Collector Cutoff Current	ІСВО	V _{CB} =40V, I _E =0A			10	μΑ
Emitter Cutoff Current	IEBO	VEB=4V, IC=0A			10	μΑ
DC Current Gain	hFE	V _{CE} =2V, I _C =1A	200		700	
Gain-Bandwidth Product	fT	V _{CE} =5V, I _C =1A		200		MHz
Output Capacitance	Cob	V _{CB} =10V, f=1MHz		60		pF
Collector-to-Emitter Saturation Voltage	V _{CE} (sat)	I _C =5A, I _B =250mA		180	360	mV
Base-to-Emitterr Saturation Voltage	V _{BE} (sat)	I _C =5A, I _B =250mA		0.93	1.4	V

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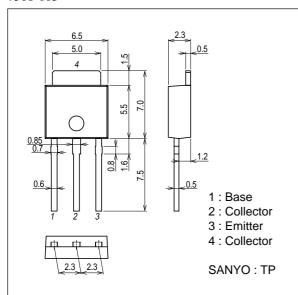
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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Oill
Collector-to-Base Breakdown Voltage	V(BR)CBO	IC=100μA, IE=0A	120			٧
Collector-to-Emitter Breakdown Voltage	V(BR)CES	I _C =100μA, R _{BE} =0Ω	120			V
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC=1mA, RBE=∞	50			V
Emitter-to-Base Breakdown Voltage	V(BR)EBO	IE=100μA, IC=0A	8			V
Turn-On Time	ton	See specified Test Circuit.		40		ns
Storage Time	tstg	See specified Test Circuit.		1000		ns
Fall Time	tf	See specified Test Circuit.		80		ns

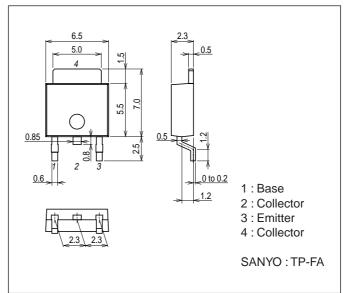
Package Dimensions

unit : mm 7518-003

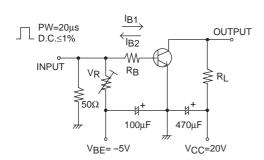


Package Dimensions

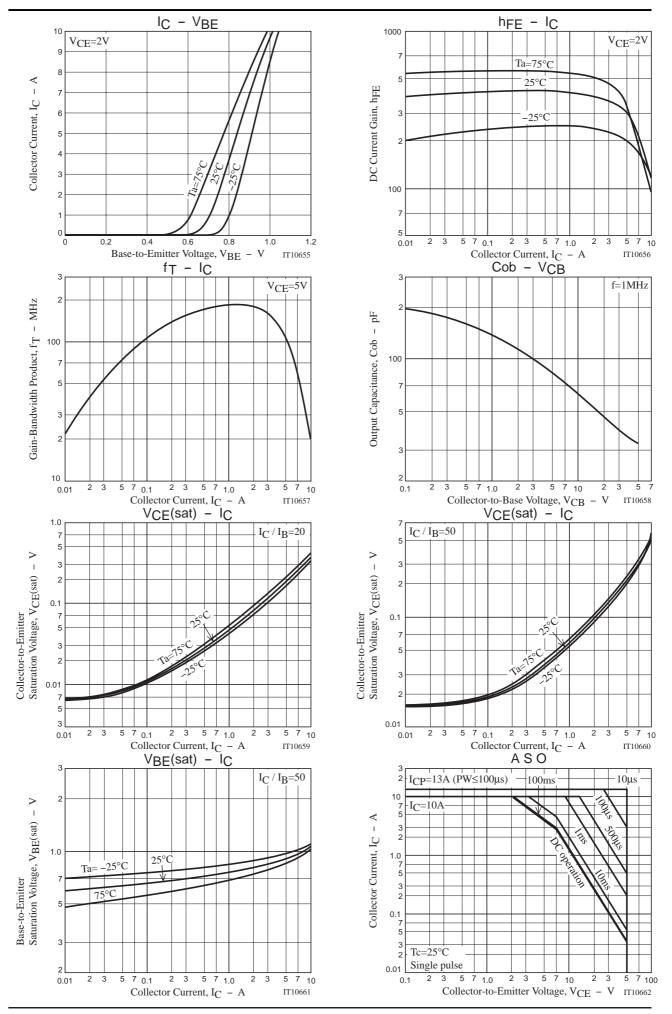
unit : mm 7003-003



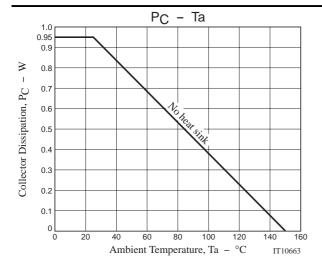
Switching Time Test Circuit

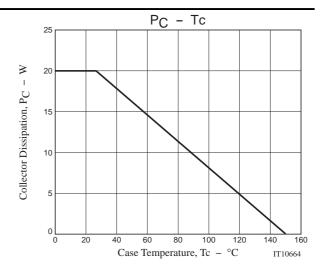


 $I_{C}=20I_{B1}=-20I_{B2}=3A$



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